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Atty.Docket No.: 10729-P67426US0

CUSTOMER NUMBER: 00136

Honorable Commissioner for Patents  
 Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application in the name of:

**Joon Ki HONG of Kyongki-do, Republic of Korea,**

for **STACK CHIP MODULE**. The application comprises a 18-page specification including 9 claims (1 independents) and Abstract, 5 sheets of drawings (Figs. 1-9), and a Declaration and Power of Attorney.

Also accompanying this application for filing are:

- (1) Assignment document, cover sheet and **\$40.00** fee for recordation of Assignment;
- (2) Information Disclosure Statement; PTO-1449 form and copies of references; and
- (3) A certified copy of **Korean** Application No. 2001-52870, filed **August 30, 2001**, the priority of which is claimed under 35 U.S.C. §119.

The filing fee has been calculated as shown:

Large Entity	\$ 740.00
Total Claims= <u>09</u> ; in excess of 20 = 0 x (\$18.00) =	0.00
Total Ind. Claims= <u>01</u> ; in excess of 03 = 0 x (\$84.00) =	+ 0.00
<b>TOTAL FILING FEE:</b>	<b>\$ 740.00</b>

A check in the amount of **\$780.00**, is enclosed to cover the Filing Fee and an Assignment Recordation Fee. The Commissioner is hereby authorized to charge payment of any fees set forth in Sections 1.16 or 1.17 during the pendency of this application, or credit any overpayment, to deposit Account No. 06-1358. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

By:

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Enclosures  
 YSH:ecl

